

RoHS Compliant Product  
A suffix of "-C" specifies halogen free

## DESCRIPTION

SSD9435 is the highest performance trench P-ch MOSFETs with extreme high cell density, which provides excellent  $R_{DS(ON)}$  and gate charge for most synchronous buck converter applications.

SSD9435 meets the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

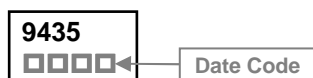
## FEATURES

- Advanced high cell density Trench technology
- Super low gate charge
- 100% EAS guaranteed

## APPLICATIONS

- Power switching applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

## MARKING



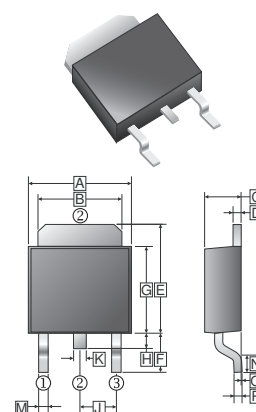
## PACKAGE INFORMATION

| Package | MPQ  | Leader Size |
|---------|------|-------------|
| TO-252  | 2.5K | 13 inch     |

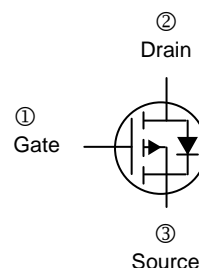
## ABSOLUTE MAXIMUM RATINGS

| Parameter  | Symbol          | Rating            | Unit         |   |
|--|-----------------|-------------------|--------------|---|
| Drain-Source Voltage   | $V_{DS}$        | -30               | V            |   |
| Gate-Source Voltage  | $V_{GS}$        | $\pm 20$          | V            |   |
| Continuous Drain Current @ $V_{GS}=10V$ <sup>1</sup>             | $I_D$           | $T_C=25^\circ C$  | -20          | A |
|  |                 | $T_C=100^\circ C$ | -13          | A |
|  |                 | $T_A=25^\circ C$  | -5.8         | A |
|  |                 | $T_A=70^\circ C$  | -4.6         | A |
| Pulsed Drain Current <sup>2</sup>                                | $I_{DM}$        | -40               | A            |   |
| Single Pulse Avalanche Energy <sup>3</sup>                       | EAS             | 18                | mJ           |   |
| Avalanche Current  | $I_{AS}$        | -19               | A            |   |
| Total Power Dissipation <sup>4</sup>                             | $P_D$           | $T_C=25^\circ C$  | 25           | W |
|  |                 | $T_A=25^\circ C$  | 2            | W |
| Maximum Thermal Resistance from Junction to Case <sup>1</sup>    | $R_{\theta JC}$ | 5                 | $^\circ C/W$ |   |
| Maximum Thermal Resistance from Junction to Ambient <sup>1</sup> | $R_{\theta JA}$ | 62                | $^\circ C/W$ |   |
| Thermal Resistance from Junction to Ambient                      | $R_{\theta JA}$ | 110               | $^\circ C/W$ |   |
| Operating Junction and Storage Temperature Range                 | $T_J, T_{STG}$  | -55 ~ 150         | $^\circ C$   |   |

## TO-252(D-Pack)



| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 6.35       | 6.9  | J    | 2.3        | REF. |
| B    | 4.95       | 5.53 | K    | 0.89       | REF. |
| C    | 2.1        | 2.5  | M    | 0.45       | 1.14 |
| D    | 0.41       | 0.9  | N    | 1.55       | Typ. |
| E    | 6          | 7.5  | O    | 0          | 0.13 |
| F    | 2.90       | REF. | P    | 0.58       | REF. |
| G    | 5.4        | 6.4  |      |            |      |
| H    | 0.6        | 1.2  |      |            |      |



**ELECTRICAL CHARACTERISTICS** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

| Parameter                                      | Symbol       | Min. | Typ. | Max.      | Unit          | Test Condition   |
|--|--------------|------|------|-----------|---------------|--|
| Drain-Source Breakdown Voltage                 | $BV_{DSS}$   | -30  | -    | -         | V             | $V_{GS}=0, I_D = -250\mu\text{A}$  |
| Gate Threshold Voltage                         | $V_{GS(th)}$ | -1   | -    | -2.5      | V             | $V_{DS}=V_{GS}, I_D = -250\mu\text{A}$   |
| Forward Transfer conductance                   | $g_{fs}$     | -    | 12   | -         | S             | $V_{DS} = -5\text{V}, I_D = -15\text{A}$   |
| Gate-Source Leakage Current                    | $I_{GSS}$    | -    | -    | $\pm 100$ | nA            | $V_{DS}=0\text{V}, V_{GS} = \pm 20\text{V}$  |
| Drain-Source Leakage Current                   | $I_{DSS}$    | -    | -    | -1        | $\mu\text{A}$ | $V_{DS} = -24\text{V}, V_{GS}=0, T_J=25^\circ\text{C}$                                       |
|  |              | -    | -    | -5        |               | $V_{DS} = -24\text{V}, V_{GS}=0, T_J=55^\circ\text{C}$                                       |
| Static Drain-Source On-Resistance <sup>2</sup> | $R_{DS(ON)}$ | -    | -    | 50        | m $\Omega$    | $V_{GS} = -10\text{V}, I_D = -15\text{A}$  |
|  |              | -    | -    | 90        |               | $V_{GS} = -4.5\text{V}, I_D = -10\text{A}$   |
| Total Gate Charge                              | $Q_g$        | -    | 6.1  | -         | pF            | $V_{DS} = -15\text{V}$<br>$V_{GS} = -4.5\text{V}$<br>$I_D = -15\text{A}$                     |
| Gate-Source Charge                             | $Q_{gs}$     | -    | 3.1  | -         |               |  |
| Gate-Drain ("Miller") Charge                   | $Q_{gd}$     | -    | 1.8  | -         |               |  |
| Turn-on Delay Time                             | $T_{d(on)}$  | -    | 2.6  | -         | nC            | $V_{DD} = -15\text{V}$<br>$V_{GS} = -10\text{V}$<br>$R_G = 3.3\Omega$<br>$I_D = -15\text{A}$ |
| Rise Time                                      | $T_r$        | -    | 8.6  | -         |               |  |
| Turn-off Delay Time                            | $T_{d(off)}$ | -    | 33.6 | -         |               |  |
| Fall Time                                      | $T_f$        | -    | 6    | -         |               |  |
| Input Capacitance                              | $C_{iss}$    | -    | 585  | -         | nS            | $V_{DS} = -15\text{V}$<br>$V_{GS} = 0$<br>$f = 1.0\text{MHz}$                                |
| Output Capacitance                             | $C_{oss}$    | -    | 100  | -         |               |  |
| Reverse Transfer Capacitance                   | $C_{rss}$    | -    | 85   | -         |               |  |
| <b>Guaranteed Avalanche Characteristics</b>    |              |      |      |           |               |  |
| Single Pulse Avalanche Energy <sup>5</sup>     | EAS          | 5    | -    | -         | mJ            | $V_{DD} = -25\text{V}, L=0.1\text{mH}, I_{AS} = -10\text{A}$                                 |
| <b>Source-Drain Diode Characteristics</b>      |              |      |      |           |               |  |
| Diode Forward Voltage <sup>2</sup>             | $V_{SD}$     | -    | -    | -1.2      | V             | $I_S = -1\text{A}, V_{GS}=0$   |
| Continuous Source Current <sup>1, 6</sup>      | $I_S$        | -    | -    | -20       | A             | $V_G=V_D=0\text{V}, \text{Force Current}$  |
| Pulsed Source Current <sup>2, 6</sup>          | $I_{SM}$     | -    | -    | -40       | A             | $V_G=V_D=0\text{V}, \text{Force Current}$  |

Notes:

- The data is tested with the surface of the device is mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- The data is tested by pulse: Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- The EAS data shows maximum rating. The test condition is  $V_{DD} = -25\text{V}, V_{GS} = -10\text{V}, L=0.1\text{mH}, I_{AS} = -19\text{A}$ .
- The power dissipation is limited by 150°C junction temperature.
- The minimum value is 100% EAS tested guarantee.
- The data is theoretically the same as  $I_D$  and  $I_{DM}$ . In real applications, the data should be limited by the total power dissipation.

**CHARACTERISTIC CURVE**

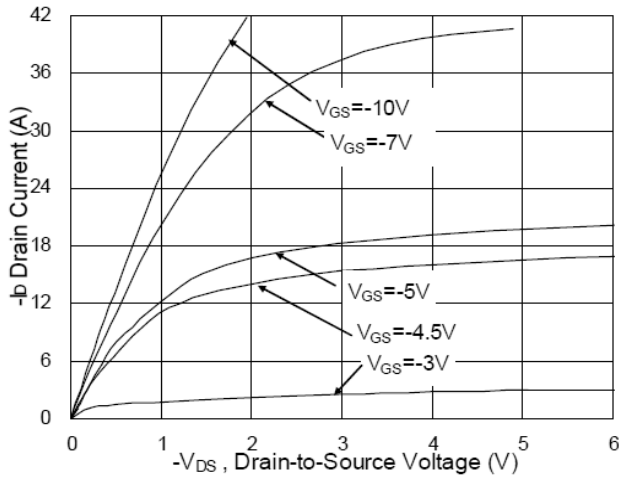


Fig.1 Typical Output Characteristics

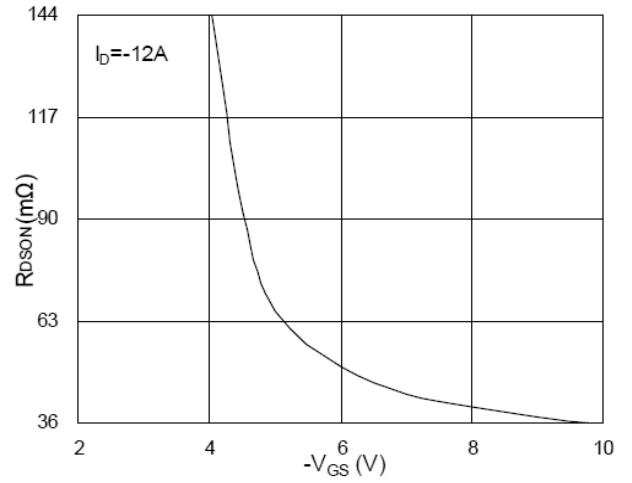


Fig.2 On-Resistance v.s Gate-Source

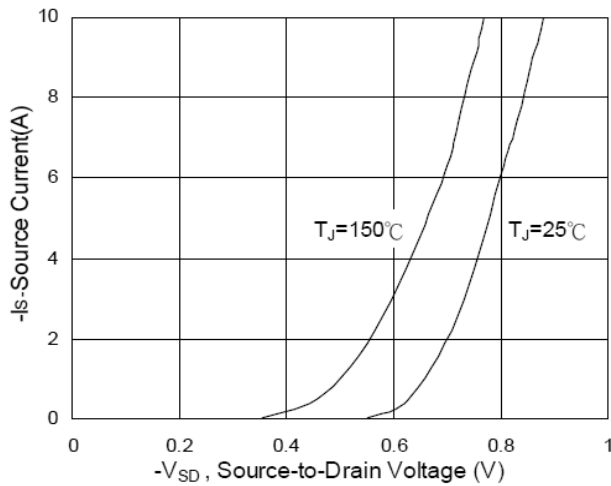


Fig.3 Forward Characteristics Of Reverse

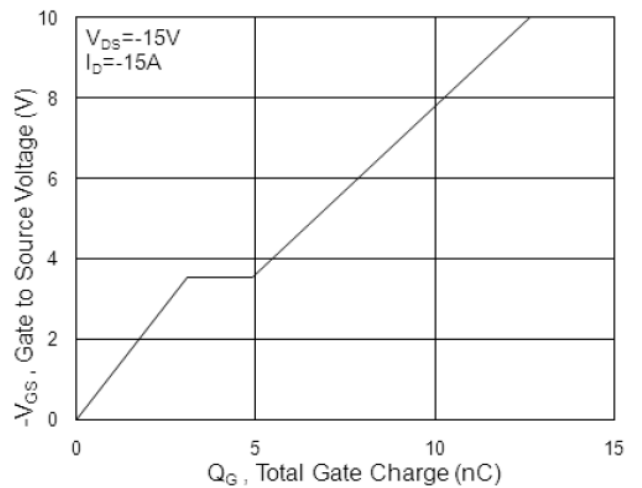


Fig.4 Gate Charge Characteristics

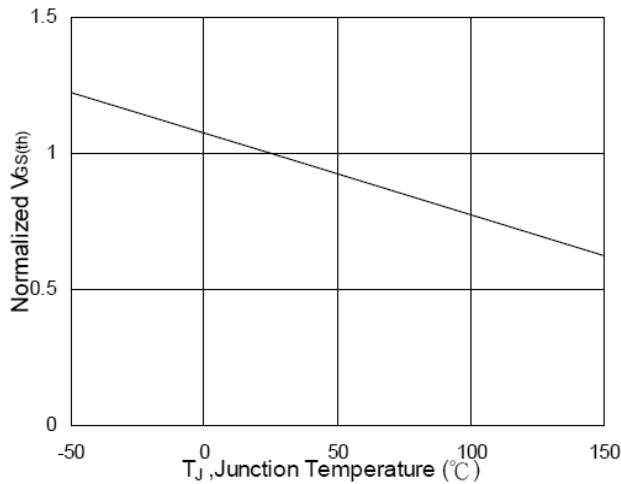


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

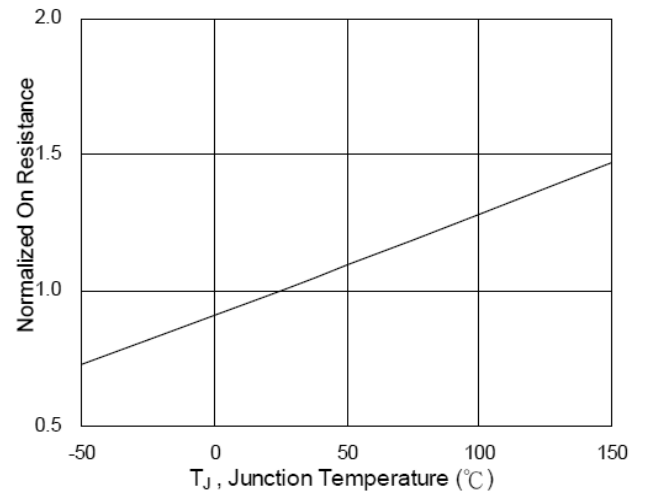


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

**CHARACTERISTIC CURVE**

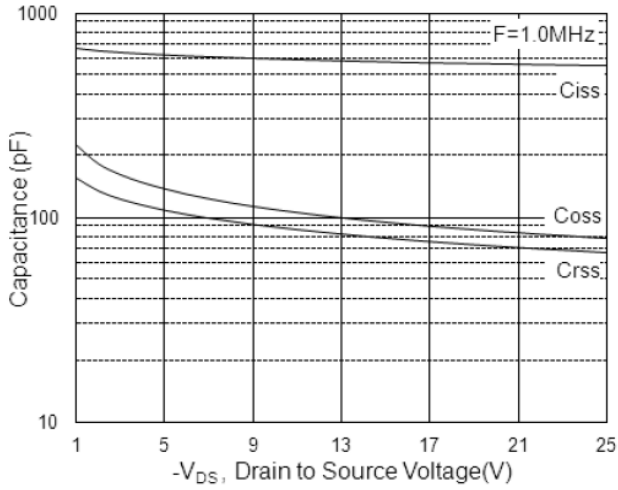


Fig.7 Capacitance

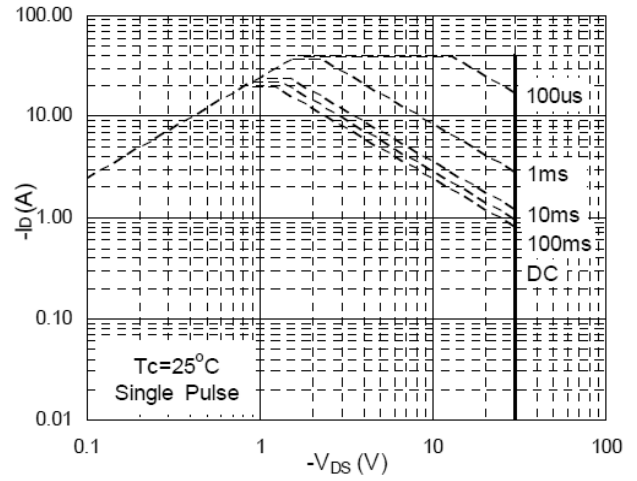


Fig.8 Safe Operating Area

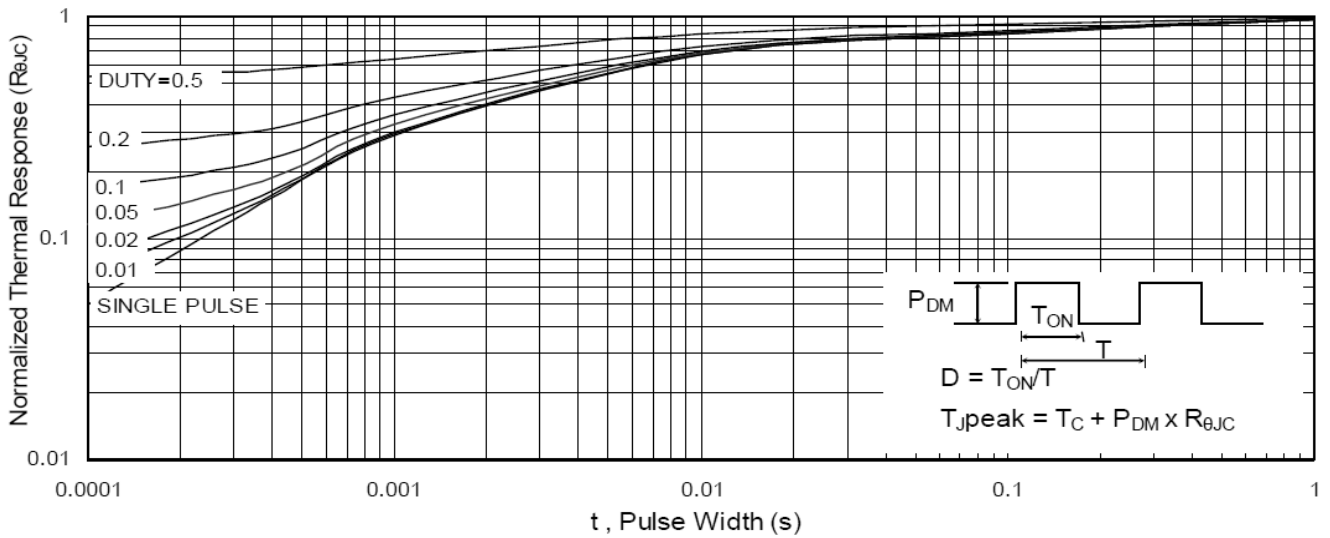


Fig.9 Normalized Maximum Transient Thermal Impedance

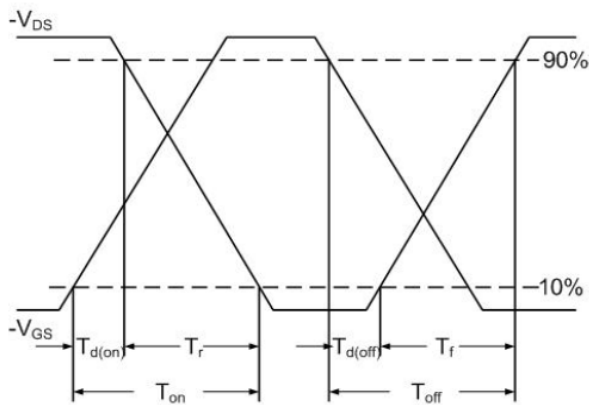


Fig.10 Switching Time Waveform

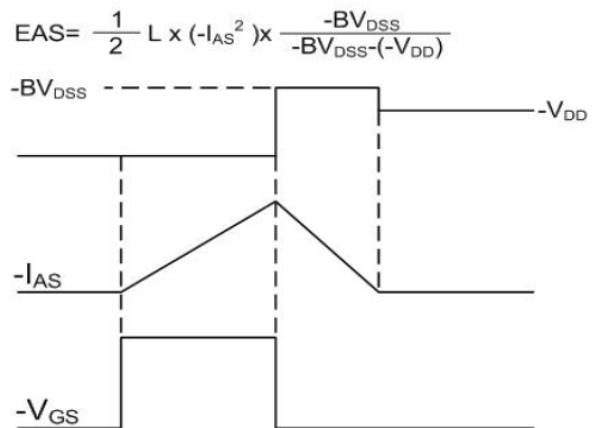


Fig.11 Unclamped Inductive Switching Waveform